



RECEIVED - MAILING DATE 9/26/01
RECEIVED - UNDER 37 C.F.R. § 1.116
EXpedited PROCEDURE
EXAMINING GROUP 1753
Corres. and Reg. 10:00 AM
BOX A
PATENT
(5298-03500/PM99021)

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Lau

Serial No. 09/476,669

Filed: December 30, 1999

For: METHOD FOR FORMING A
METALLIZATION STRUCTURE IN
AN INTEGRATED CIRCUIT

Group Art Unit: 1753
Examiner: Cantelmo, G.
Atty. Dkt. No. 5298-03500

I hereby certify that this correspondence is being deposited with the U.S. Postal Service with sufficient postage as First Class Mail in an envelope addressed to: Box AF, Commissioner for Patents, Washington, D.C. 20231, on the date indicated below:

November 26, 2001
Date

Kevin L. Daffer

AMENDMENT; RESPONSE AFTER FINAL REJECTION
PURSUANT TO 37 CFR § 1.116

Box AF
Commissioner for Patents
Washington, D.C. 20231

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JAN 15 2002
TC 1700

Dear Sir/Madam:

This paper is submitted in response to the Office Action mailed September 26, 2001 to further highlight reasons why the application is in condition for allowance.

Please amend the case as follows.